

March 2013

FDB2710

N-Channel PowerTrench[®] MOSFET 250 V, 50 A, 42.5 m Ω

Features

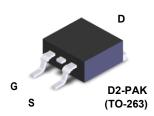
- $R_{DS(on)}$ = 36.3 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 25 A
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- Low Gate Charge
- High Power and Current Handling Capability

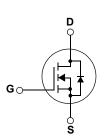
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor[®]'s PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification
- Battery Protection Circuit
- Motor drives and Uninterruptible Power Supplies





Absolute Maximum Ratings

Symbol	Parameter			FDB2710	Unit
V _{DS}	Drain-Source Voltage			250	V
V _{GS}	Gate-Source voltage			±30	V
ID	Drain Current - Continuous ($T_C = 25^{\circ}C$) - Continuous ($T_C = 100^{\circ}C$)			50 31.3	A A
I _{DM}	Drain Current - Pulsed (Note 1) See Figure		- Pulsed (Note 1)		A
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			145	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)			4.5	V/ns
P _D	Power Dissipation (T _C = 25°C) - Derate above 25°C			260 2.1	W W/°C
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

°C/W						
°C/W						
R _{0JA} *Thermal Resistance, Junction-to-Ambient, Max. *62.5°C/W						
_						

Device Marking Device Pa		ckage Reel Size Tap		e Widt	h	Quantity 800				
FDB2	FDB2710 FDB2710 D2		2-Pak 330mm		24mm					
Electric	al Chai	racteristics T	_C = 25°C ur	nless otherwi	se noted					
Symbol	Parameter		Conditions		Min	Тур	Max	Unit		
Off Charac	teristics									
BV _{DSS}	Drain-Source Breakdown Voltage		V_{GS} = 0V, I_{D} = 250 μ A, T_{J} = 25°C		250			V		
ΔΒV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient		I _D = 250μA, Referenced to 25°C			0.25		V/°C		
I _{DSS}	Zero Gate Voltage Drain Current		$V_{DS} = 250V, V_{GS} = 0V$ $V_{DS} = 250V, V_{GS} = 0V, T_C = 125^{\circ}C$				1 500	μ Α μΑ		
I _{GSSF}	Gate-Bod	y Leakage Current, F	orward	$V_{GS} = 30V, V_{DS} = 0V$				100	nA	
I _{GSSR}	Gate-Bod	y Leakage Current, F	Reverse	$V_{GS} = -30V, V_{DS} = 0V$				-100	nA	
On Charac	teristics									
V _{GS(th)}	Gate Thre	e Threshold Voltage		$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		3.0	4.0	5.0	V	
R _{DS(on)}	Static Drain-Source On-Resistance		V _{GS} = 10V, I _D = 25A			36.3	42.5	mΩ		
9 _{FS}	Forward 7	rward Transconductance		V _{DS} = 10V, I _D = 25A			63		S	
Dynamic C	haracteris	tics		1						
C _{iss}	Input Cap	nput Capacitance Dutput Capacitance						5470	7280	pF
C _{oss}	Output Ca			V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz			426	570	pF	
C _{rss}	Reverse Transfer Capacitance					97	146	pF		
Switching	Characteri	istics								
t _{d(on)}	Turn-On Delay Time		V _{DD} = 125V, I _D = 50A			80	170	ns		
t _r	Turn-On F	Rise Time		V _{GS} = 10V, R _{GEN} = 25Ω			252	515	ns	
t _{d(off)}	Turn-Off [Delay Time					112	235	ns	
t _f	Turn-Off F	Fall Time				(Note 4)		154	320	ns
Qg	Total Gate	e Charge		$V_{DS} = 125V, I_D = 50A$ $V_{GS} = 10V$			78	101	nC	
Q _{gs}	Gate-Sou	rce Charge					34		nC	
Q _{gd}	Gate-Drai	rain Charge (Note 4		(Note 4)		18		nC		
Drain-Sour	ce Diode (Characteristics and	Maximun	n Ratings						
S Maximum Continuous Drain-Source Dioc			de Forward Current				50	Α		
I _{SM}	Maximum Pulsed Drain-Source Diode Fo		prward Current				150	Α		
V _{SD}	Drain-Sou	urce Diode Forward V	/oltage	V _{GS} = 0V, I _S = 50A				1.2	V	
t _{rr}	Reverse F	Recovery Time		V _{GS} = 0V				163		ns
Q _{rr}	Reverse F	Recovery Charge		dl _F /dt =100A/μs				1.3		μC

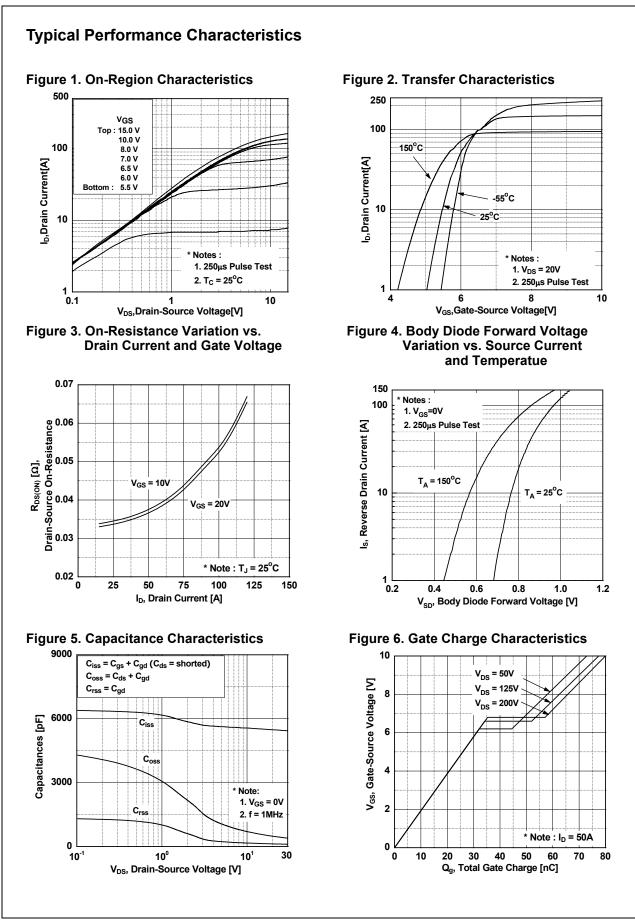
Notes:

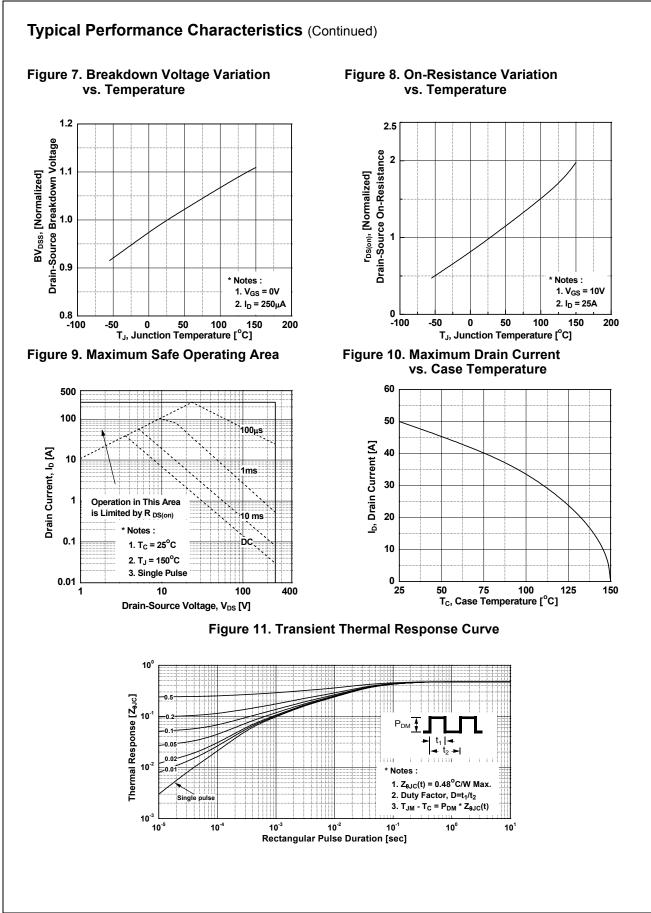
1. Repetitive Rating: Pulse width limited by maximum junction temperature

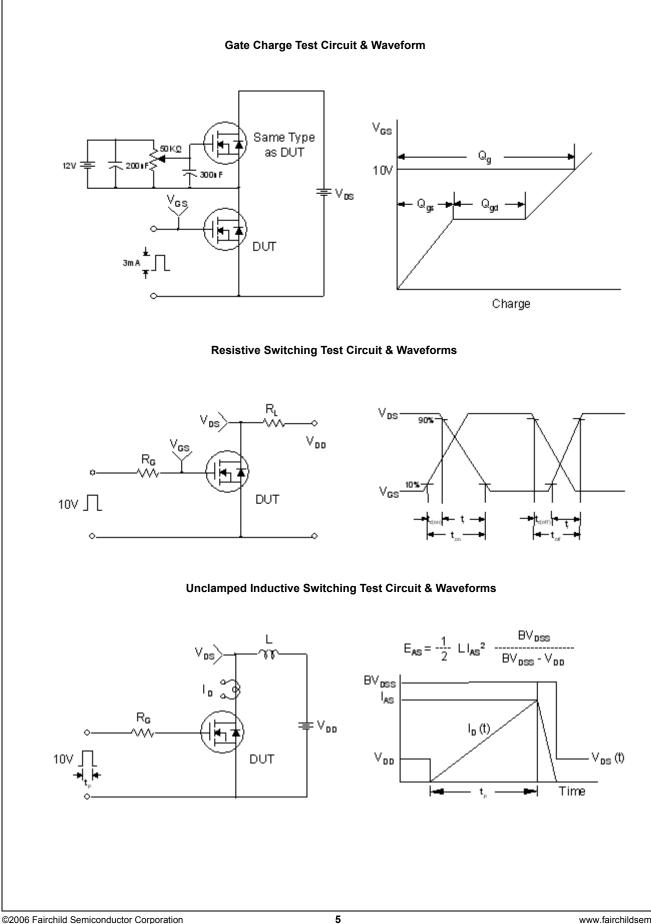
2. L = 1mH, I_{AS} = 17A, V_{DD} = 50V, R_G = 25\Omega, Starting T_J = 25°C

3. $I_{SD} \leq$ 50A, di/dt \leq 100A/ $\mu s,~V_{DD} \leq BV_{DSS},~Starting~T_J$ = 25°C

4. Essentially Independent of Operating Temperature Typical Characteristics

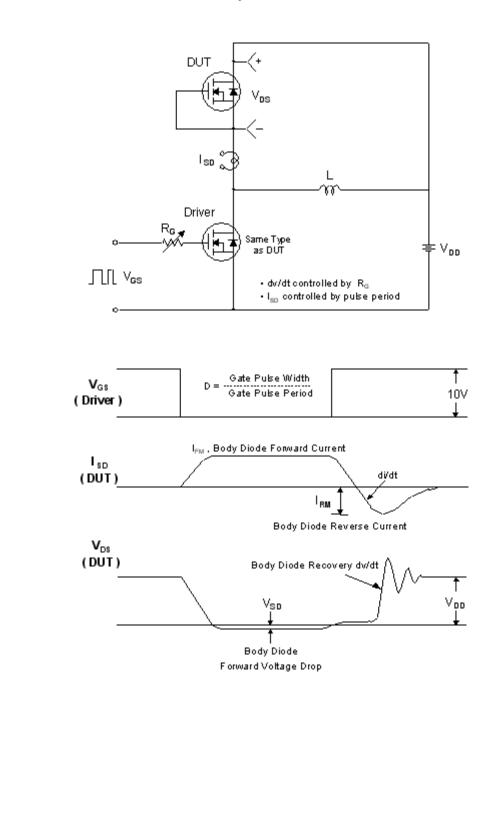


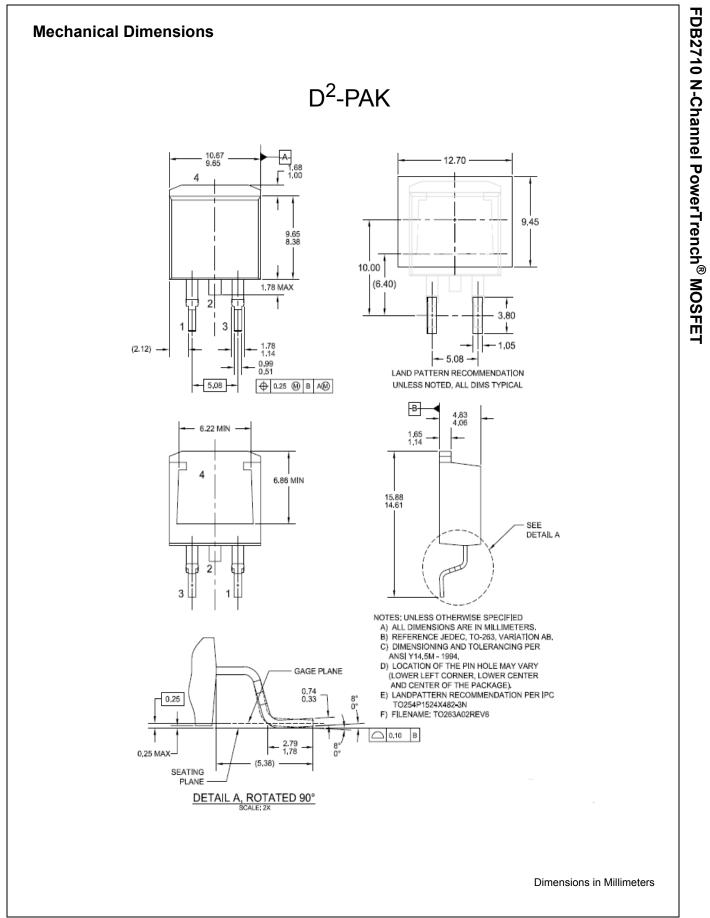




FDB2710 N-Channel PowerTrench[®] MOSFET

Peak Diode Recovery dv/dt Test Circuit & Waveforms







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